

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number:

0743011000

Status:

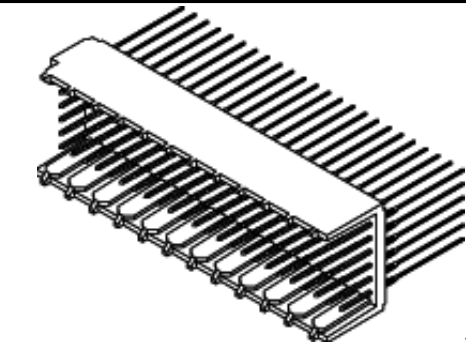
Active

Overview:

[hdm](#)

Description:

2.00mm (.079") Pitch HDM® Board-to-Board Backplane Header, Vertical, SMC, Press-Fit, Extended PC Tail, Open End Option, 144 Circuits



Series
image - Reference only

Documents:

[Drawing \(PDF\)](#)

[RoHS Certificate of Compliance \(PDF\)](#)

General	
Product Family	Backplane Connectors
Series	74301
Application	Backplane
Component Type	PCB Header
Overview	hdm
Product Name	HDM®
Style	N/A
Physical	
Circuits (Loaded)	144
Circuits (maximum)	144
Color - Resin	Black, Natural
Durability (mating cycles max)	250
First Mate / Last Break	No
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin-Lead
Material - Resin	High Temperature Thermoplastic
Number of Columns	24
Number of Pairs	Open Pin Field
Number of Rows	6
Orientation	Vertical
PC Tail Length (in)	0.276 In
PC Tail Length (mm)	7.00 mm
PCB Retention	Yes
PCB Thickness Recommended (in)	0.098 In
PCB Thickness Recommended (mm)	2.50 mm
Packaging Type	Tube
Pitch - Mating Interface (in)	0.079 In
Pitch - Mating Interface (mm)	2.00 mm
Pitch - Term. Interface (in)	0.079 In
Pitch - Term. Interface (mm)	2.00 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.75
Plating min: Termination (µin)	15
Plating min: Termination (µm)	0.375
Polarized to PCB	No
Stackable	No
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical	
Current - Maximum per Contact	1A

EU RoHS

Compliance Status

Not Reviewed

REACH SVHC

Not Reviewed

Halogen-Free

Status

Not Reviewed

China RoHS

Need more information on product environmental compliance?

Email productcompliance@molex.com

For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[74301Series](#)

Data Rate	1.0 Gbps
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC

Material Info

Reference - Drawing Numbers

Packaging Specification	PK-70873-0868
Sales Drawing	SD-74301-001

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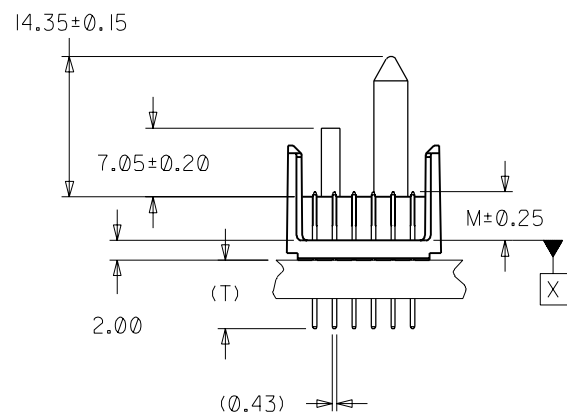
- NOTES:
1. MATERIALS: HOUSING-LIQUID CRYSTAL POLYMER (LCP),
GLASS-FILLED, UL94V-0, COLOR: BLACK,
CONTACT-PHOSPHOR BRONZE.
 2. FINISH: SELECTIVE GOLD (Au) IN CONTACT AREA,
0.00076mm MINIMUM THICKNESS, SELECTIVE TIN/LEAD (Sn/Pb) ON TAILS,
NICKEL (Ni) OVERALL.
 3. THIS PART CONFORMS TO MOLEX PRODUCT SPECIFICATION
PS-73670-9999.
 4. PACKAGED PER PK-70873-0868.
 5. PARTS MARKED WITH PART NUMBER AND DATE CODE,
ON EITHER SIDE, APPROXIMATELY WHERE SHOWN.



OPEN END OPTION

END WALL OPTION

REVISED EC NO. UCP2003-2260 DRWN: THOMAS 03/04/25 CHK: BINGHAM 03/04/25 APPR: REED 03/04/25 D	DESCRIPTION	QUALITY SYMBOLS MAJOR CRITICAL	GENERAL TOLERANCES: (UNLESS SPECIFIED)		SCALE 2 : 1	DESIGN UNITS ☒ mm ☐ INCH	 THIRD ANGLE PROJECTION	☐ mm INCH ☐ mm	☒ mm ONLY	REVISE ON CAD ONLY	
				mm	INCH	DRAWN BY & DATE JBINGHAM 99/01/21		TITLE: SALES ASSEMBLY, HDM BACKPLANE CONNECTOR EXTENDED TAIL VERSION			
			4 PLACES	±0.	±.	CHECKED BY & DATE SREED 99/01/21		MOLEX INCORPORATED			
			3 PLACES	±0.	±.	APPROVED BY & DATE CBIXLER 99/01/21					
			2 PLACES	±0.05	±.	CAD FILENAME S74301X1.DGN					
	1 PLACE	±0.10	±.	ANGULAR: ± 1/2°							
	REV			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.					SIZE B



SEE SHEET 1 EC NO. UDT2000-0413 DRWG:JBINGHAM 99/11/02 CHK'd: SREED 99/11/02 APPR: CBIXLER 99/11/02 C	DESCRIPTION REV	QUALITY SYMBOLS MAJOR CRITICAL	GENERAL TOLERANCES: (UNLESS SPECIFIED):		SCALE 2 : 1	DESIGN UNITS ☒ mm ☐ INCH	 THIRD ANGLE PROJECTION	DIMENSIONS: ☐ mm ☐ INCH ☒ mm ONLY	SHT REVISE ON CAD ONLY	REV ON CAD ONLY	
				mm	INCH	DRAWN BY & DATE JBINGHAM 99/01/21		TITLE: SALES ASSEMBLY, HDM BACKPLANE CONNECTOR EXTENDED TAIL VERSION			
			4 PLACES	±0.	±.	CHECKED BY & DATE SREED 99/01/21		MOLEX INCORPORATED			
			3 PLACES	±0.	±.	APPROVED BY & DATE CBIXLER 99/01/21					
			2 PLACES	±0.05	±.	CAD FILENAME S74301X2.DGN		MATERIAL NO. SEE CHART	DRAWING NO. SD-74301-001	SHEET NO. 2	
			1 PLACE	±0.10	±.	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.					SIZE B
			ANGULAR: ± 1/2°		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS						

MATERIAL NUMBER ASSIGNMENT

0 = 72-CIRCUIT OPEN END
1 = 144-CIRCUIT OPEN END
2 = 72-CIRCUIT END WALL
3 = 144-CIRCUIT END WALL
4 = 72-CIRCUIT POALR/GUIDE
5 = 144-CIRCUIT POLAR/GUIDE

0 = 5.0mm MATING, 7.0mm TAIL
1 = 5.5mm MATING, 7.0mm TAIL
2 = 6.0mm MATING, 7.0mm TAIL

74301- * * * *

NUMBER	GUIDE POST LOCATION	POLAR KEY POSITION
00	N/A	N/A
01	B	A
02	A	
03	B	B
04	A	
05	B	C
06	A	
07	B	D
08	A	
09	B	E
10	A	
11	B	F
12	A	
13	B	G
14	A	
15	B	H
16	A	
17	B	N/A
18	A	

PART NUMBER	DIM A	DIM B	DIM M	DIM T
74301-0000	23.8	22.00	5.00	7.00
74301-0100	23.8	22.00	5.50	7.00
74301-0200	23.8	22.00	6.00	7.00
74301-1000	47.8	46.00	5.00	7.00
74301-1100	47.8	46.00	5.50	7.00
74301-1200	47.8	46.00	6.00	7.00
74301-2000	27.6	22.00	5.00	7.00
74301-2100	27.6	22.00	5.50	7.00
74301-2200	27.6	22.00	6.00	7.00
74301-3000	51.6	46.00	5.00	7.00
74301-3100	51.6	46.00	5.50	7.00
74301-3200	51.6	46.00	6.00	7.00
74301-40**	31.6	22.00	5.00	7.00
74301-41**	31.6	22.00	5.50	7.00
74301-42**	31.6	22.00	6.00	7.00
74301-50**	55.6	46.00	5.00	7.00
74301-51**	55.6	46.00	5.50	7.00
74301-52**	55.6	46.00	6.00	7.00



PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: 2.50 MIN.

SEE SHEET 1
EC NO. UDT2000-0413
DRWN:JBINGHAM 99/11/02
CHK: SREED 99/11/02
APPR:CBIXLER 99/11/02

DESCRIPTION
MAJOR
CRITICAL

REV

GENERAL TOLERANCES:
(UNLESS SPECIFIED)

mm

INCH

4 PLACES ±0. ±.

3 PLACES ±0. ±.

2 PLACES ±0.05 ±.

1 PLACE ±0.10 ±.

ANGULAR: ± 1/2°

DRAFT WHERE APPLICABLE MUST
REMAIN WITHIN DIMENSIONS

SCALE
2 : 1

DESIGN UNITS
mm INCH

DRAWN BY & DATE
JBINGHAM 99/01/21

CHECKED BY & DATE
SREED 99/01/21

APPROVED BY & DATE
CBIXLER 99/01/21

CAD FILENAME
S74301X3.DGN

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX
INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.

DIMENSIONS:
mm INCH mm ONLY

THIRD ANGLE
PROJECTION

TITLE:
SALES ASSEMBLY, HDM
BACKPLANE CONNECTOR
EXTENDED TAIL VERSION

MOLEX
MOLEX INCORPORATED

MATERIAL NO.
SEE CHART

DRAWING NO.
SD-74301-001

SHT
3

REV
B

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

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<http://moschip.ru/get-element>

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

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